

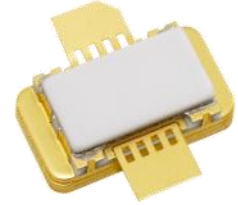
■ Features

- High Voltage Operation : $V_{DS}=50V$
- High Power : 54.6dBm (typ.) @ P_{sat}
- Proven Reliability

■ Description

Sumitomo Electric's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power L-band amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use in 0.9GHz W-CDMA and LTE design requirements as it offers high gain, long term reliability and ease of use.


ABSOLUTE MAXIMUM RATINGS (Case Temperature $T_c=25\text{deg.C}$)

Item	Symbol	Condition	Rating	Unit
Operating Voltage	V_{DS}		55	V
Drain-Source Voltage	V_{DS}	$V_{GS}=-8V$	160	V
Gate-Source Voltage	V_{GS}		-15	V
Total Power Dissipation	P_t		160.7	W
Storage Temperature	T_{stg}		-65 to +175	deg.C
Channel Temperature	T_{ch}		250	deg.C

RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	V_{DS}		≤ 55	V
Forward Gate Current	I_{GF}	$R_G=10\text{ ohm}$	≤ 406	mA
Reverse Gate Current	I_{GR}	$R_G=10\text{ ohm}$	≥ -13.8	mA
Channel Temperature	T_{ch}		≤ 200	deg.C
Average Output Power	$P_{ave.}$		≤ 51.6	dBm

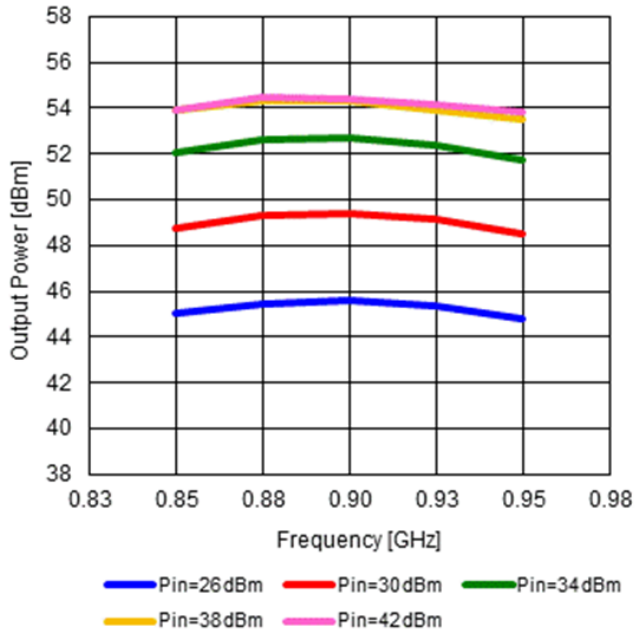
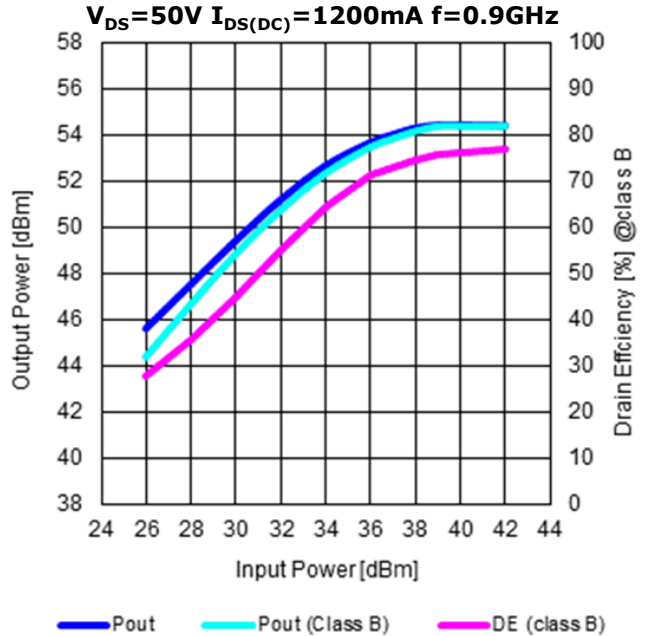
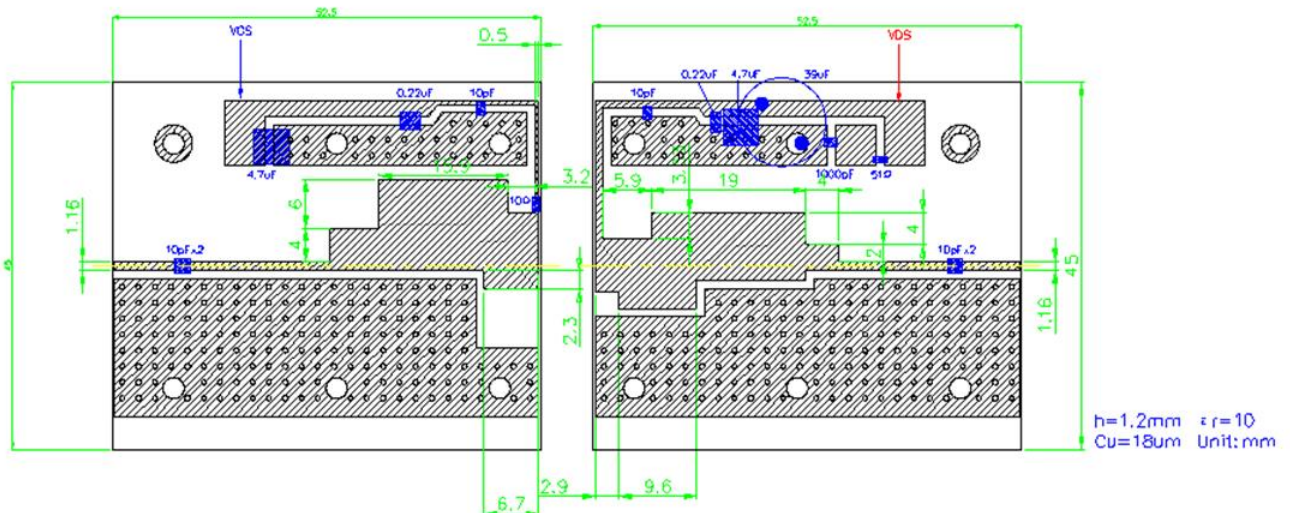
ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25\text{deg.C}$)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	V_p	$V_{DS}=50V$ $I_{DS}=48\text{mA}$	-4.0	-	-2.0	V
Saturated Power	$P_{sat} *1$	$V_{DS}=50V$	53.6	54.6	-	dBm
Drain Efficiency at P_{sat}	$DE *1$	$I_{DS(DC)}=0\text{mA}$ $f=0.9\text{GHz}$	65.0	72.0	-	%
Power Gain	$G_p *2$	$V_{DS}=50V$ $I_{DS(DC)}=800\text{mA}$ $f=0.9\text{GHz}$	16.5	17.5	-	dB
Thermal Resistance	R_{th}	Channel to Case at 105W P_{DC}	-	1.2	1.4	deg.C/W

*1 : 10%-duty RF pulse (DC supply constant), Fixed Pin=39dBm

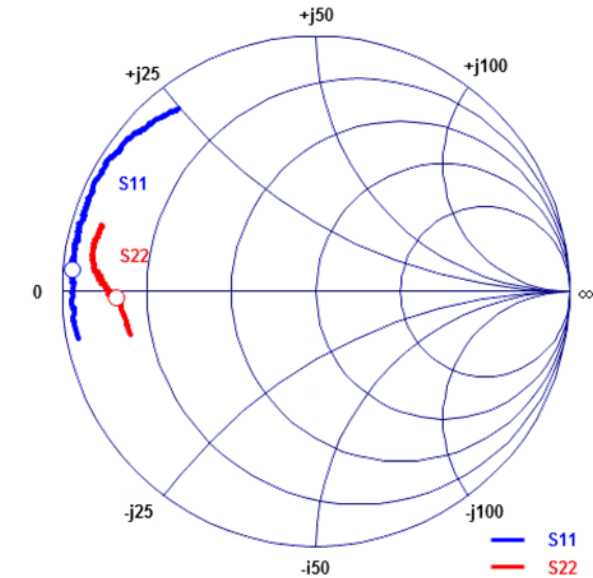
*2 : $P_{out}=46\text{dBm}$, CW modulation Signal (W-CDMA)

RoHS Compliance	YES
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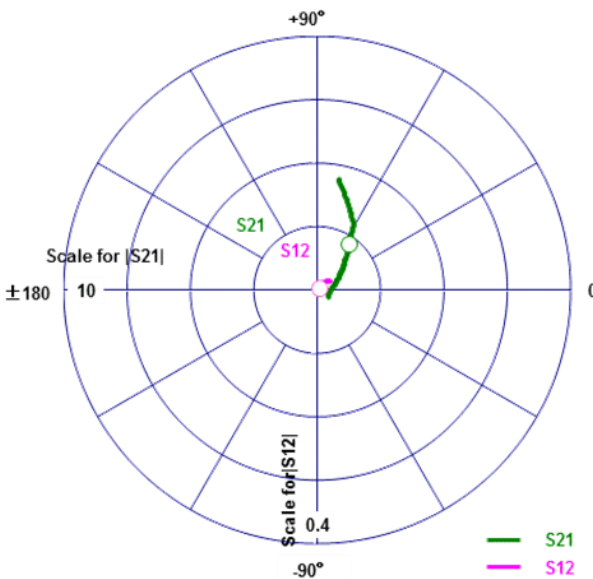
RF characteristics @f=0.9GHz fine tuned
Output Power vs. Frequency
 $V_{DS}=50V$ $I_{DS(DC)}=1200mA$

Output Power and Drain Efficiency vs. Input Power
 $V_{DS}=50V$ $I_{DS(DC)}=1200mA$ $f=0.9GHz$

Pulse Signal (10%-duty, DC : constant)
Test Fixture


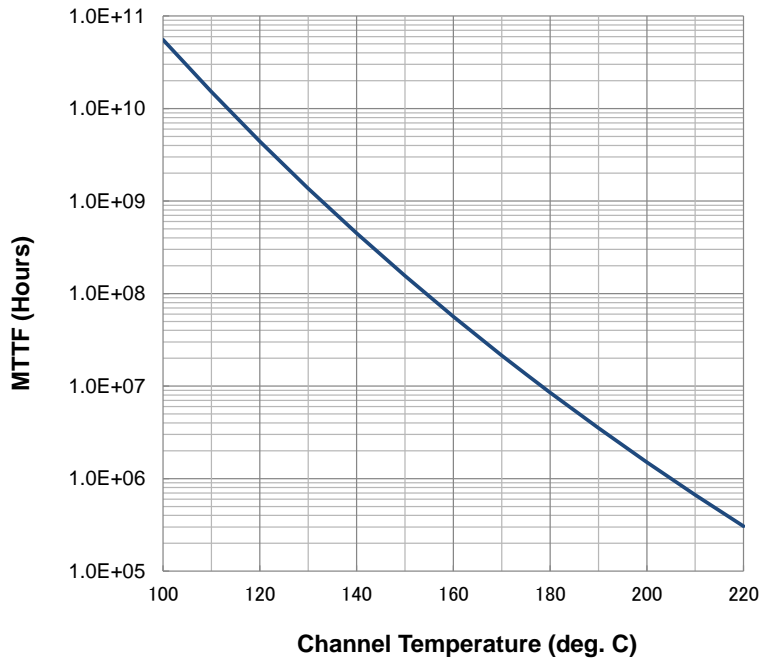
- Reference DATA -

S-Parameters @VDS=50V, IDS(DC)=1200mA, f=0.5 to 4.5GHz
ZI = Zs = 50ohm Marker : 0.9GHz



Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.5	0.96	-169.00	4.45	78.80	0.005	14.70	0.75	-167.00
0.6	0.96	-176.00	3.58	69.70	0.005	10.80	0.76	-172.00
0.7	0.96	177.00	2.95	60.60	0.005	6.05	0.77	-177.00
0.8	0.96	176.00	2.51	57.80	0.004	8.36	0.78	-178.00
0.9	0.96	175.00	2.22	54.90	0.005	13.70	0.79	-178.00
1.0	0.97	174.00	1.98	51.10	0.005	11.80	0.79	-178.00
1.1	0.97	173.00	1.75	48.50	0.005	15.80	0.80	-178.00
1.2	0.97	172.00	1.57	46.00	0.005	18.50	0.80	-179.00
1.3	0.97	171.00	1.44	42.70	0.005	23.20	0.81	-180.00
1.4	0.97	170.00	1.33	39.70	0.005	24.10	0.82	-180.00
1.5	0.97	169.00	1.22	37.40	0.005	27.30	0.82	180.00
1.6	0.96	168.00	1.11	34.90	0.005	27.60	0.82	179.00
1.7	0.96	167.00	1.04	31.60	0.005	32.10	0.83	179.00
1.8	0.97	166.00	0.98	29.00	0.006	36.80	0.84	178.00
1.9	0.97	166.00	0.92	26.80	0.006	37.20	0.85	178.00
2.0	0.97	165.00	0.86	25.10	0.006	38.20	0.85	178.00
2.1	0.97	164.00	0.81	21.80	0.006	38.60	0.84	177.00
2.2	0.96	163.00	0.77	19.20	0.006	39.00	0.86	177.00
2.3	0.97	162.00	0.73	17.40	0.006	42.60	0.86	176.00
2.4	0.97	161.00	0.70	15.40	0.007	44.40	0.87	176.00
2.5	0.97	160.00	0.67	13.00	0.007	45.20	0.86	175.00
2.6	0.97	159.00	0.63	10.40	0.007	45.10	0.87	175.00
2.7	0.97	158.00	0.61	8.52	0.008	45.90	0.88	174.00
2.8	0.97	157.00	0.59	6.31	0.008	45.10	0.88	174.00
2.9	0.97	156.00	0.57	4.29	0.008	47.20	0.88	174.00
3.0	0.97	155.00	0.55	2.50	0.009	47.90	0.88	173.00
3.1	0.97	154.00	0.54	0.67	0.009	49.50	0.89	172.00
3.2	0.97	152.00	0.53	-1.51	0.010	49.30	0.89	172.00
3.3	0.96	151.00	0.52	-3.42	0.010	49.50	0.89	171.00
3.4	0.97	150.00	0.51	-5.53	0.011	50.20	0.89	171.00
3.5	0.97	148.00	0.50	-7.16	0.012	50.70	0.89	170.00
3.6	0.96	147.00	0.50	-9.33	0.013	49.80	0.90	169.00
3.7	0.95	145.00	0.49	-12.00	0.013	49.00	0.89	169.00
3.8	0.95	143.00	0.49	-14.10	0.014	47.50	0.89	168.00
3.9	0.96	141.00	0.49	-16.70	0.015	45.10	0.89	167.00
4.0	0.94	139.00	0.50	-19.00	0.016	45.10	0.89	166.00
4.1	0.94	138.00	0.50	-21.00	0.018	45.20	0.89	166.00
4.2	0.93	135.00	0.50	-23.70	0.019	44.20	0.89	165.00
4.3	0.92	133.00	0.51	-26.50	0.021	41.80	0.89	164.00
4.4	0.91	130.00	0.51	-29.40	0.023	39.00	0.88	164.00
4.5	0.90	127.00	0.52	-32.30	0.025	35.60	0.88	163.00



**MTTF Calculation
- Estimated MTTF -**


Ea=1.6eV
Confidence Level=90%

Channel Temp (deg.C)	MTTF (Hours)
160	5.98 x 10 ⁷
180	9.02 x 10 ⁶
200	1.60 x 10 ⁶

$$AF = \exp\left[-\frac{Ea}{k}\left(\frac{1}{T_{stress}} - \frac{1}{T_{use}}\right)\right]$$

$$MTTF_{use} = MTTF_{stress} * AF$$

Where;

AF: acceleration factor

Ea: activation energy (1.6 eV)

k: Boltzman's constant (8.62 x 10⁻⁵ eV/K)

T_{stress}: stress temperature (K)

T_{use}: use temperature (K)

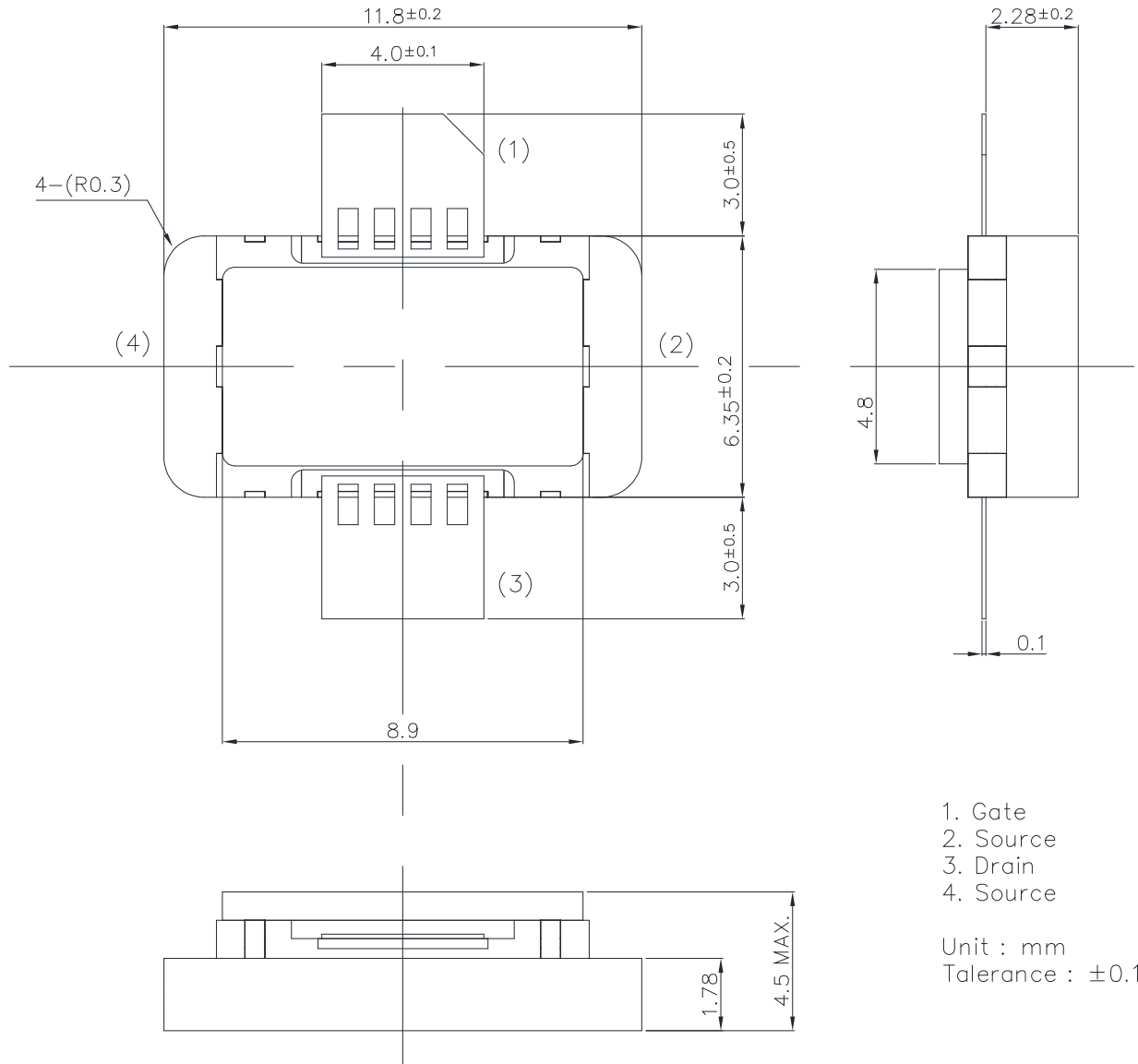
ESD characteristic

Test Methodology	Class
Human Body Model (per JESD22-A114)	1B
Machine Model (per JEIA/ESD22-A115)	A
Device Charged Model (per JESD22-C101)	IV

Ordering Information

Part Number	MOQ / MOU	Tray Style
SGNH240M1H	No Limitation	30pcs Tray (30 pockets)
SGNH240M1H/001	No Limitation	JEDEC Tray (100 pockets)

M1H Package Outline
Metal-Ceramic Hermetic Package



For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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